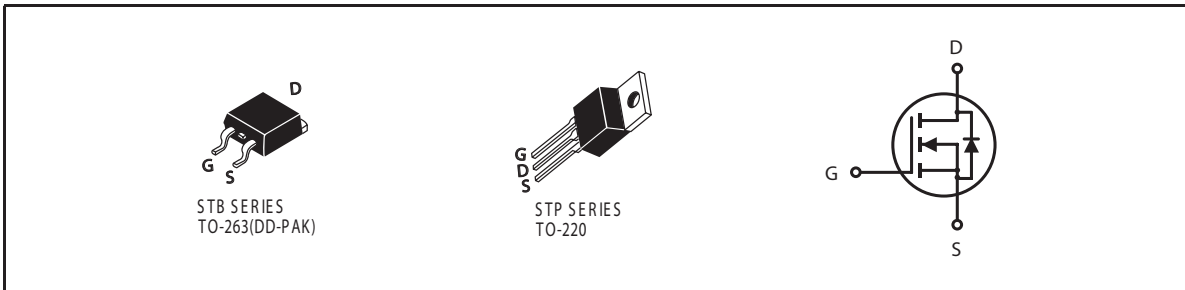


**N-Channel Logic Level Enhancement Mode Field Effect Transistor****PRODUCT SUMMARY**

V _{DSS}	I _D	R _{DS(ON)} (mΩ) Typ
60V	50A	16 @ V _{GS} =10V
		22 @ V _{GS} =4.5V

FEATURES

- Super high dense cell design for extremely low R_{DS(ON)}.
- High power and current handling capability.
- TO-220 & TO-263 package.

**ABSOLUTE MAXIMUM RATINGS (T_C=25°C unless otherwise noted)**

Symbol	Parameter	Limit	Units
V _{DS}	Drain-Source Voltage	60	V
V _{GS}	Gate-Source Voltage	±20	V
I _D	Drain Current-Continuous ^a	T _C =25°C	50
		T _C =100°C	32
I _{DM}	-Pulsed ^b	145	A
E _{AS}	Avalanche Energy ^c	125	mJ
P _D	Maximum Power Dissipation ^a	T _C =25°C	76
		T _C =100°C	30
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 to 150	°C

THERMAL CHARACTERISTICS

R _{θJC}	Thermal Resistance, Junction-to-Case	1.32	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient	62.5	°C/W

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ELECTRICAL CHARACTERISTICS (T_C=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	60			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =48V, V _{GS} =0V			1	A
I _{GSS}	Gate-Body leakage current	V _{GS} = ±20V, V _{DS} =0V			±100	nA
ON CHARACTERISTICS						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	1	2	3	V
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =10V, I _D =25A		16	20	m ohm
		V _{GS} =4.5V, I _D =20A		22	30	m ohm
g _{FS}	Forward Transconductance	V _{DS} =10V, I _D =25A		30		S
DYNAMIC CHARACTERISTICS ^b						
C _{ISS}	Input Capacitance	V _{DS} =15V, V _{GS} =0V f=1.0MHz		2190		pF
C _{OSS}	Output Capacitance			218		pF
C _{RSS}	Reverse Transfer Capacitance			144		pF
SWITCHING CHARACTERISTICS ^b						
t _{D(ON)}	Turn-On DelayTime	V _{DD} =15V I _D =1A		54		ns
t _r	Rise Time			84		ns
t _{D(OFF)}	Turn-Off DelayTime	V _{GS} =10V R _{GEN} =60 ohm		150		ns
t _f	Fall Time			46		ns
Q _g	Total Gate Charge	V _{DS} =15V, I _D =25A, V _{GS} =10V		33		nC
Q _{gs}	Gate-Source Charge	V _{DS} =15V, I _D =25A, V _{GS} =10V		5.4		nC
Q _{gd}	Gate-Drain Charge			10.8		nC
DRAIN-SOURCE DIODE CHARACTERISTICS						
I _S	Maximum Continuous Drain-Source Diode Forward Current				25	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _S =25A		0.84	1.3	V
Notes						
a. Pulse Test: Pulse Width ≤ 300us, Duty Cicle ≤ 2%.						
b. Guaranteed by design, not subject to production testing.						
c. Starting T _J =25°C, L=1.25mH, V _{DD} =30V, V _{GS} =10V. (See Figure13)						

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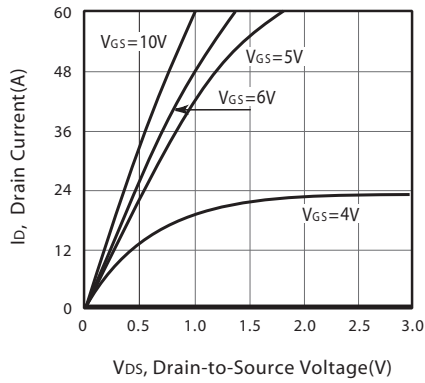


Figure 1. Output Characteristics

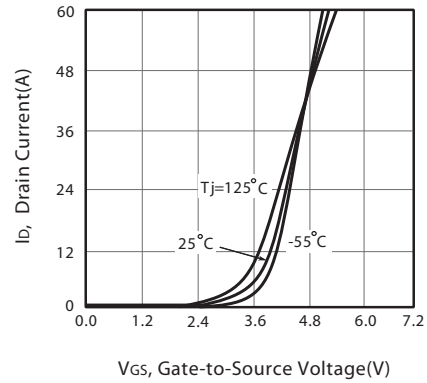


Figure 2. Transfer Characteristics

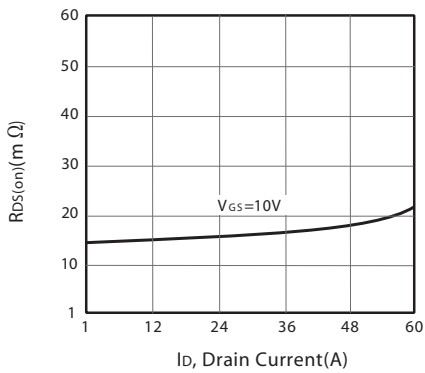


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

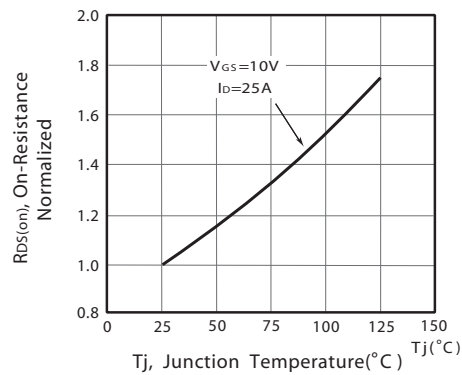


Figure 4. On-Resistance Variation with Drain Current and Temperature

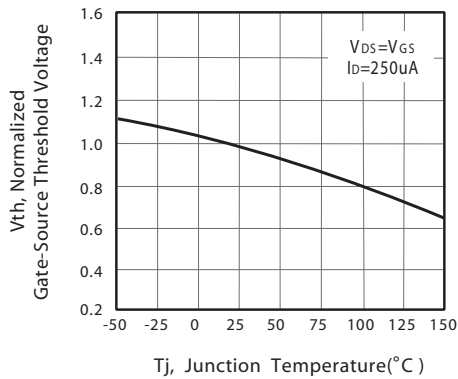


Figure 5. Gate Threshold Variation with Temperature

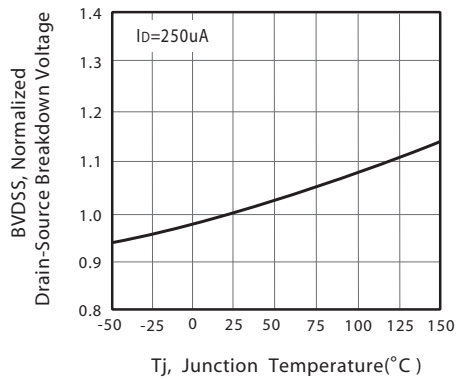


Figure 6. Breakdown Voltage Variation with Temperature

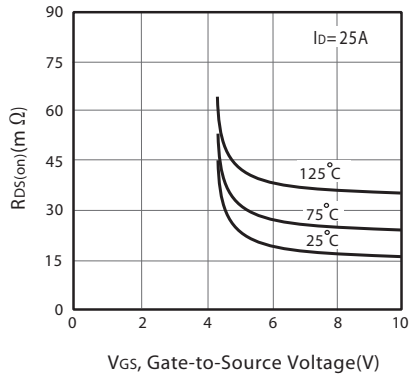


Figure 7. On-Resistance vs. Gate-Source Voltage

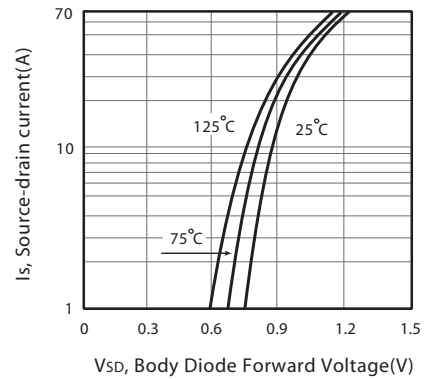


Figure 8. Body Diode Forward Voltage Variation with Source Current

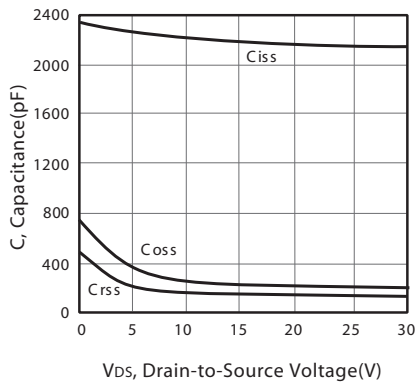


Figure 9. Capacitance

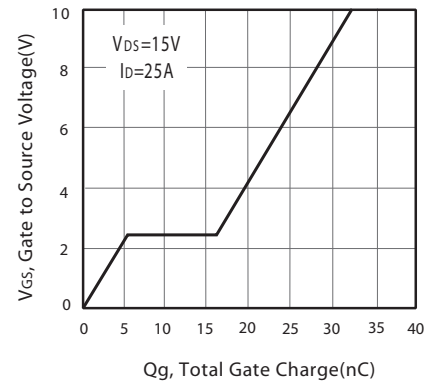


Figure 10. Gate Charge

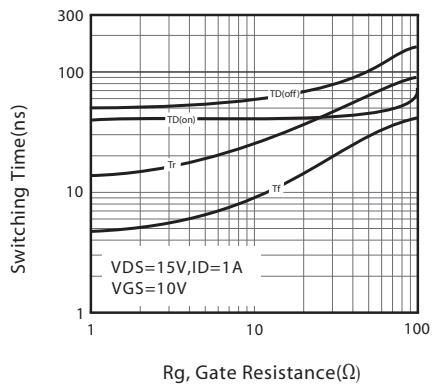


Figure 11. switching characteristics

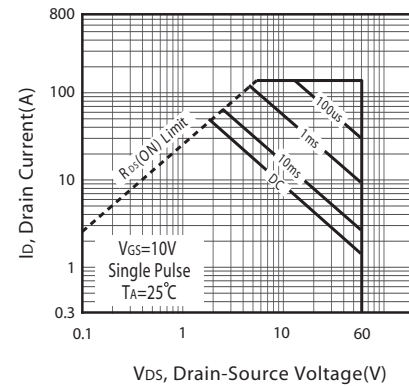
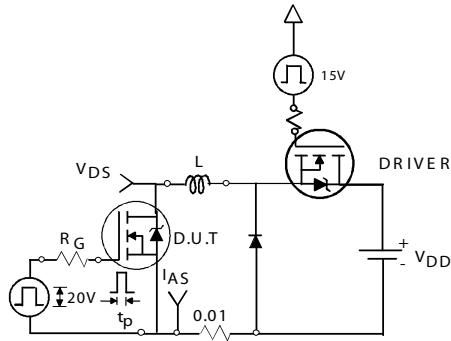
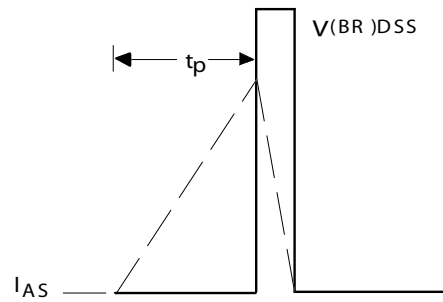


Figure 12. Maximum Safe Operating Area



Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

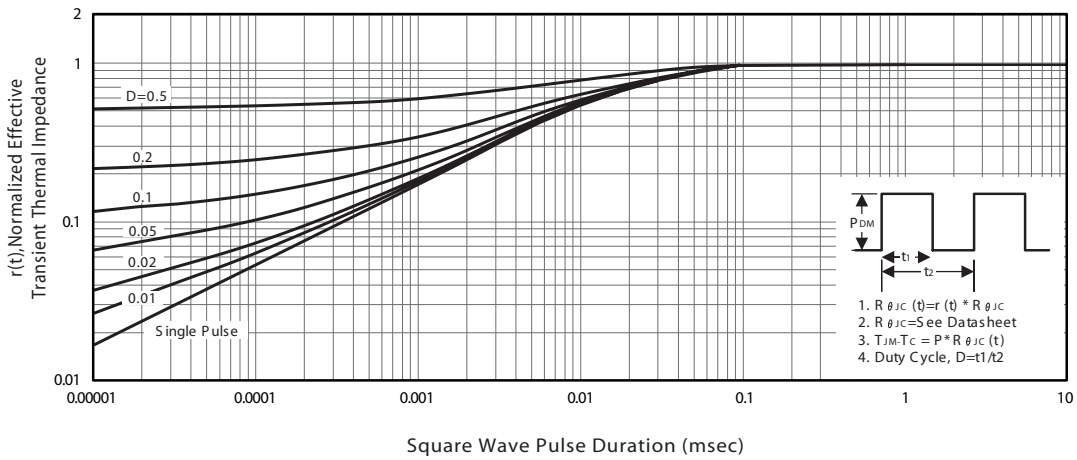


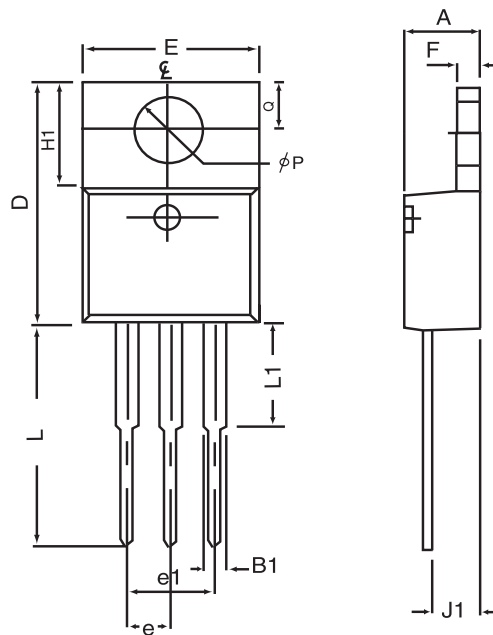
Figure 14. Normalized Thermal Transient Impedance Curve

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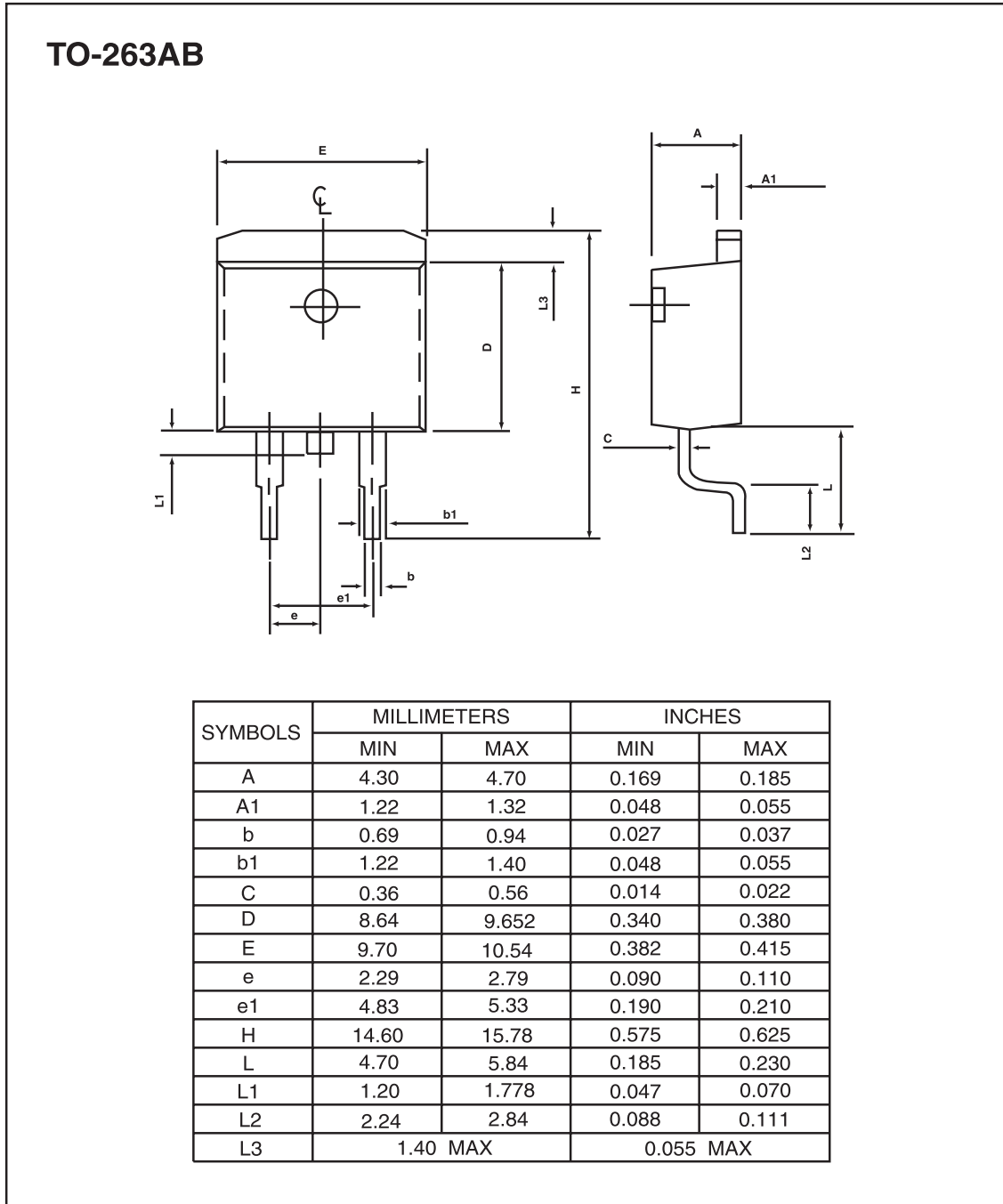
TO-220



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.32	4.80	0.170	0.189
B1	1.27	1.65	0.050	0.630
D	14.6	16.00	0.575	0.610
E	9.70	10.41	0.382	0.410
e	2.34	2.74	0.092	0.108
e1	4.68	5.48	0.184	0.216
F	1.14	1.40	0.045	0.055
H1	5.97	6.73	0.235	0.265
J1	2.20	2.79	0.087	0.110
L	12.88	14.22	0.507	0.560
L1	3.00	6.35	0.120	0.250
phi P	3.50	3.94	0.138	0.155
Q	2.54	3.05	0.100	0.120

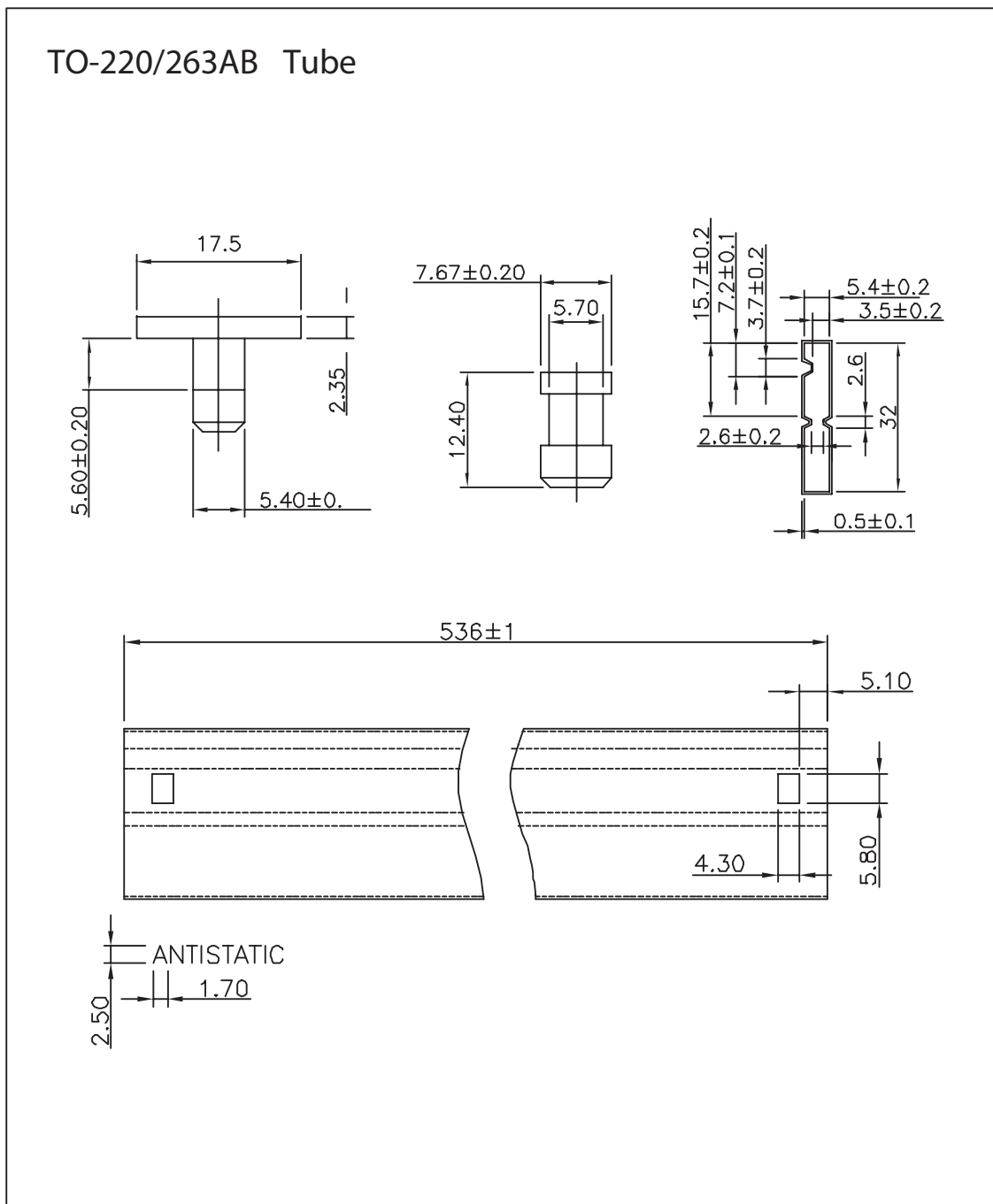
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